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# International Rectifier

INSULATED GATE BIPOLAR TRANSISTOR WITH  
ULTRAFAST SOFT RECOVERY DIODE

PD- 91777

## IRG4PH20KD

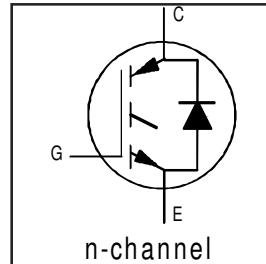
Short Circuit Rated  
UltraFast IGBT

### Features

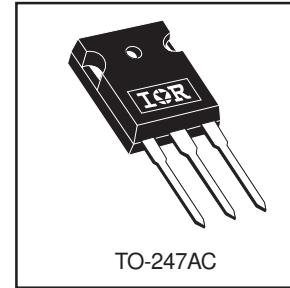
- High short circuit rating optimized for motor control,  $t_{sc} = 10\mu s$ ,  $V_{CC} = 720V$ ,  $T_J = 125^{\circ}C$ ,  $V_{GE} = 15V$
- Combines low conduction losses with high switching speed
- Tighter parameter distribution and higher efficiency than previous generations
- IGBT co-packaged with HEXFRED™ ultrafast, ultrasoft recovery antiparallel diodes

### Benefits

- Latest generation 4 IGBT's offer highest power density motor controls possible
- HEXFRED™ diodes optimized for performance with IGBTs. Minimized recovery characteristics reduce noise, EMI and switching losses



$V_{CES} = 1200V$
$V_{CE(on)} \text{ typ.} = 3.17V$ $\text{@ } V_{GE} = 15V, I_C = 5.0A$



TO-247AC

### Absolute Maximum Ratings

	Parameter	Max.	Units
$V_{CES}$	Collector-to-Emitter Voltage	1200	V
$I_C @ T_C = 25^{\circ}C$	Continuous Collector Current	11	
$I_C @ T_C = 100^{\circ}C$	Continuous Collector Current	5.0	
$I_{CM}$	Pulsed Collector Current ①	22	A
$I_{LM}$	Clamped Inductive Load Current ②	22	
$I_F @ T_C = 100^{\circ}C$	Diode Continuous Forward Current	5.0	
$I_{FM}$	Diode Maximum Forward Current	22	
$t_{sc}$	Short Circuit Withstand Time	10	$\mu s$
$V_{GE}$	Gate-to-Emitter Voltage	$\pm 20$	V
$P_D @ T_C = 25^{\circ}C$	Maximum Power Dissipation	60	
$P_D @ T_C = 100^{\circ}C$	Maximum Power Dissipation	24	W
$T_J$	Operating Junction and	$-55$ to $+150$	
$T_{STG}$	Storage Temperature Range		
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	
	Mounting Torque, 6-32 or M3 Screw.	10 lbf·in (1.1 N·m)	

### Thermal Resistance

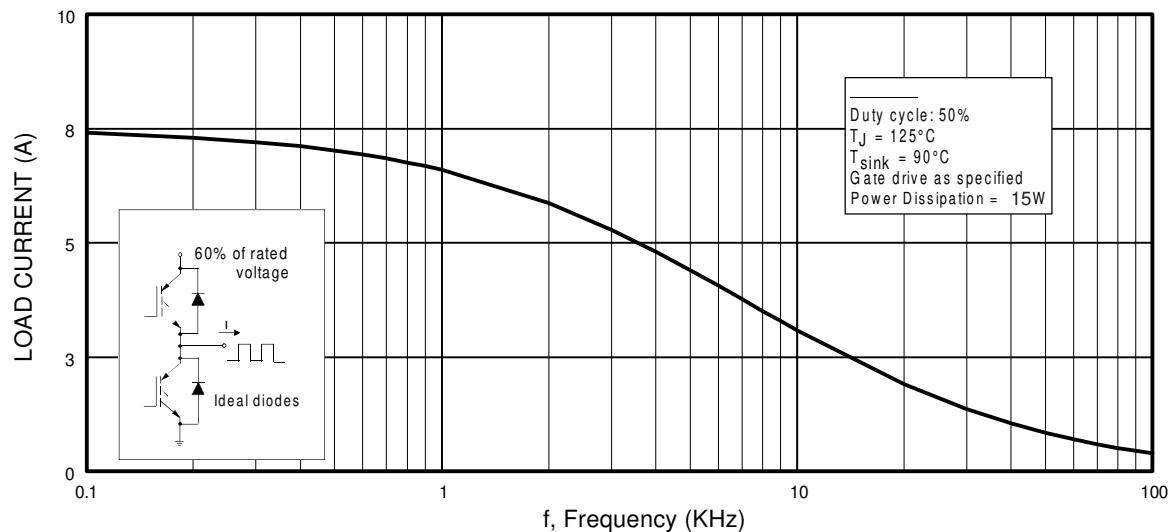
	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case - IGBT	—	—	2.1	
$R_{\theta JC}$	Junction-to-Case - Diode	—	—	3.5	$^{\circ}C/W$
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	40	
Wt	Weight	—	6 (0.21)	—	g (oz)

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

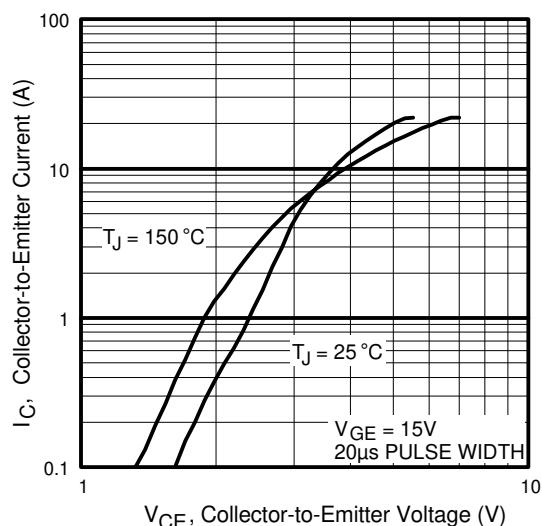
	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage <sup>③</sup>	1200	—	—	V	$V_{\text{GE}} = 0\text{V}$ , $I_C = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	1.13	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}$ , $I_C = 2.5\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	3.17	4.3	V	$I_C = 5.0\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	4.04	—		$I_C = 11\text{A}$ See Fig. 2, 5
		—	2.84	—		$I_C = 5.0\text{A}$ , $T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.5	—	6.5		$V_{\text{CE}} = V_{\text{GE}}$ , $I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-10	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}$ , $I_C = 1\text{mA}$
$g_{\text{fe}}$	Forward Transconductance <sup>④</sup>	2.3	3.5	—	S	$V_{\text{CE}} = 100\text{V}$ , $I_C = 5.0\text{A}$
$I_{\text{CES}}$	Zero Gate Voltage Collector Current	—	—	250	$\mu\text{A}$	$V_{\text{GE}} = 0\text{V}$ , $V_{\text{CE}} = 1200\text{V}$
		—	—	1000		$V_{\text{GE}} = 0\text{V}$ , $V_{\text{CE}} = 1200\text{V}$ , $T_J = 150^\circ\text{C}$
$V_{\text{FM}}$	Diode Forward Voltage Drop	—	2.5	2.9	V	$I_C = 5.0\text{A}$ See Fig. 13
		—	2.2	2.6		$I_C = 5.0\text{A}$ , $T_J = 150^\circ\text{C}$
$I_{\text{GES}}$	Gate-to-Emitter Leakage Current	—	—	$\pm 100$	nA	$V_{\text{GE}} = \pm 20\text{V}$

**Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

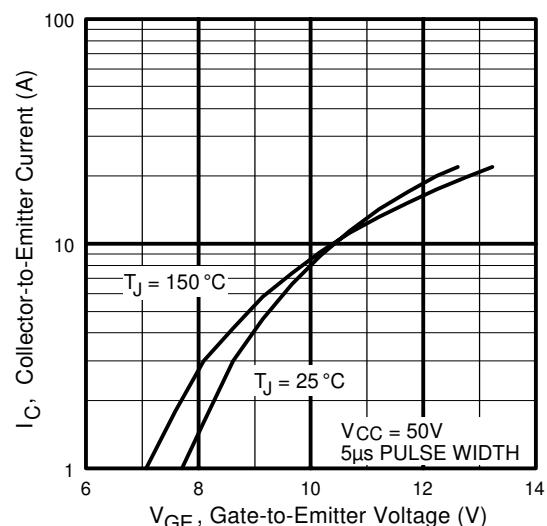
	Parameter	Min.	Typ.	Max.	Units	Conditions
$Q_g$	Total Gate Charge (turn-on)	—	28	43	nC	$I_C = 5.0\text{A}$
$Q_{ge}$	Gate - Emitter Charge (turn-on)	—	4.4	6.6		$V_{\text{CC}} = 400\text{V}$ See Fig.8
$Q_{gc}$	Gate - Collector Charge (turn-on)	—	12	18		$V_{\text{GE}} = 15\text{V}$
$t_{d(\text{on})}$	Turn-On Delay Time	—	50	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 5.0\text{A}$ , $V_{\text{CC}} = 800\text{V}$ $V_{\text{GE}} = 15\text{V}$ , $R_G = 50\Omega$ Energy losses include "tail" and diode reverse recovery See Fig. 9,10,18
$t_r$	Rise Time	—	30	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	100	150		
$t_f$	Fall Time	—	250	380		
$E_{\text{on}}$	Turn-On Switching Loss	—	0.62	—	mJ	See Fig. 9,10,18
$E_{\text{off}}$	Turn-Off Switching Loss	—	0.30	—		
$E_{ts}$	Total Switching Loss	—	0.92	1.2		
$t_{sc}$	Short Circuit Withstand Time	10	—	—	$\mu\text{s}$	$V_{\text{CC}} = 720\text{V}$ , $T_J = 125^\circ\text{C}$ $V_{\text{GE}} = 15\text{V}$ , $R_G = 50\Omega$
$t_{d(\text{on})}$	Turn-On Delay Time	—	50	—	ns	$T_J = 150^\circ\text{C}$ , See Fig. 10,11,18 $I_C = 5.0\text{A}$ , $V_{\text{CC}} = 800\text{V}$ $V_{\text{GE}} = 15\text{V}$ , $R_G = 50\Omega$ , Energy losses include "tail" and diode reverse recovery
$t_r$	Rise Time	—	30	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	110	—		
$t_f$	Fall Time	—	620	—		
$E_{ts}$	Total Switching Loss	—	1.6	—	mJ	
$L_E$	Internal Emitter Inductance	—	13	—	nH	Measured 5mm from package
$C_{\text{ies}}$	Input Capacitance	—	435	—	pF	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$
$C_{\text{oes}}$	Output Capacitance	—	44	—		
$C_{\text{res}}$	Reverse Transfer Capacitance	—	8.3	—		
$t_{rr}$	Diode Reverse Recovery Time	—	51	77	ns	$T_J = 25^\circ\text{C}$ See Fig.
		—	68	102		$T_J = 125^\circ\text{C}$ 14
$I_{rr}$	Diode Peak Reverse Recovery Current	—	6.0	9.0	A	$T_J = 25^\circ\text{C}$ See Fig.
		—	7.0	11		$T_J = 125^\circ\text{C}$ 15
		—	183	274		$T_J = 25^\circ\text{C}$ See Fig.
$Q_{rr}$	Diode Reverse Recovery Charge	—	285	427	nC	$T_J = 125^\circ\text{C}$ 16
		—	380	—		$T_J = 25^\circ\text{C}$ See Fig.
		—	307	—		$T_J = 125^\circ\text{C}$ 17
$dI_{(\text{rec})M}/dt$	Diode Peak Rate of Fall of Recovery During $t_b$	—	—	A/ $\mu\text{s}$		$I_F = 5.0\text{A}$ $V_R = 200\text{V}$ $di/dt = 200\text{A}/\mu\text{s}$
		—	—			



**Fig. 1 - Typical Load Current vs. Frequency**  
 (Load Current =  $I_{RMS}$  of fundamental)



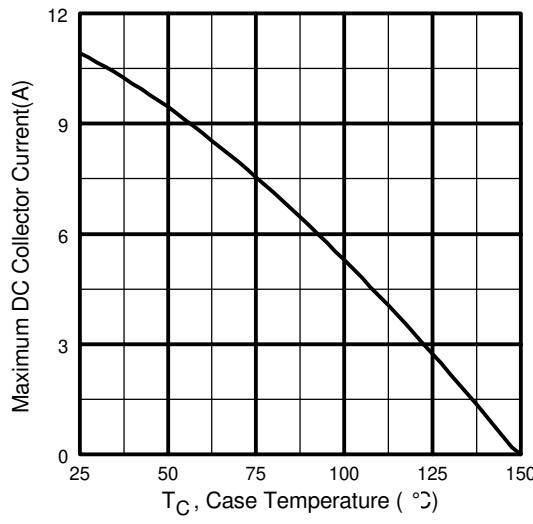
**Fig. 2 - Typical Output Characteristics**  
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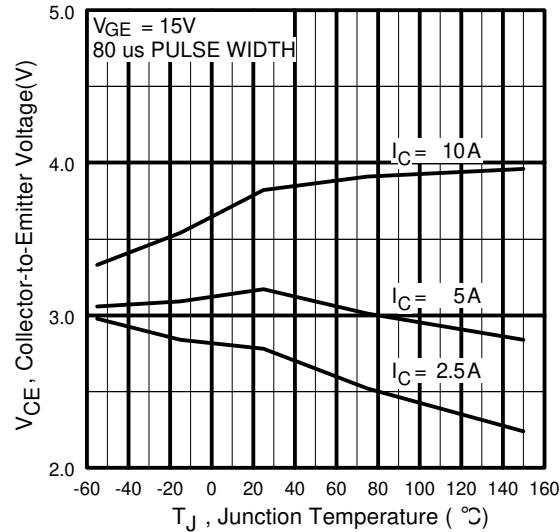
**Fig. 3 - Typical Transfer Characteristics**  
 3

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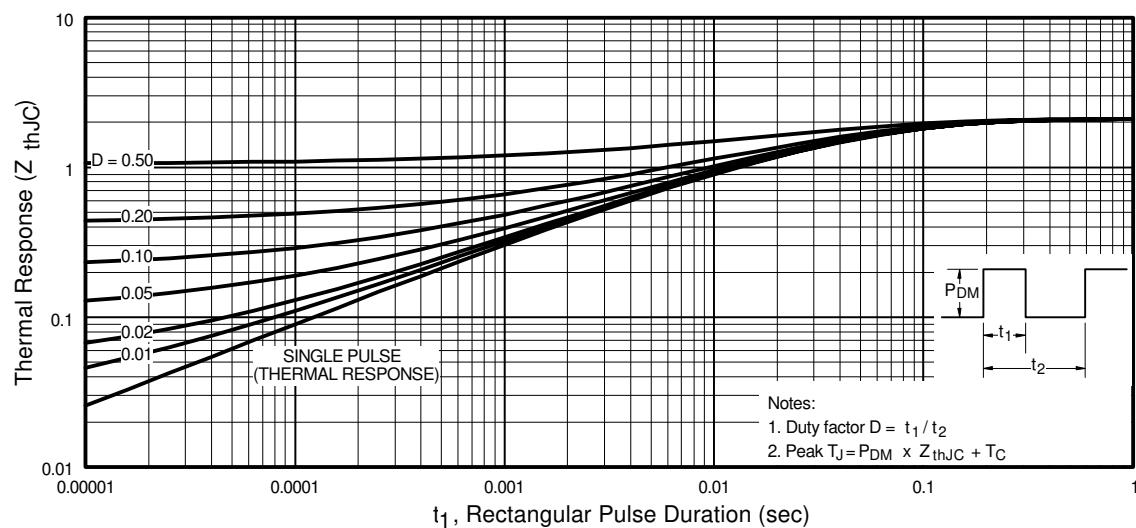
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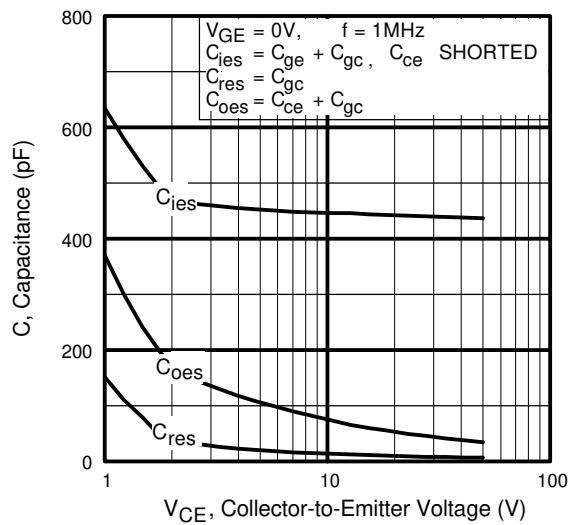
**Fig. 4** - Maximum Collector Current vs. Case Temperature



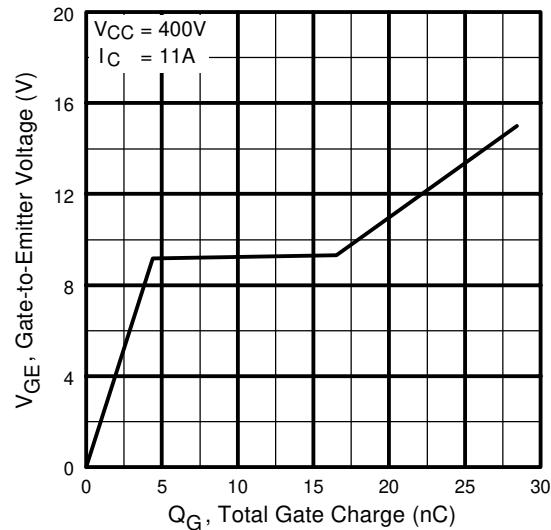
**Fig. 5** - Typical Collector-to-Emitter Voltage vs. Junction Temperature



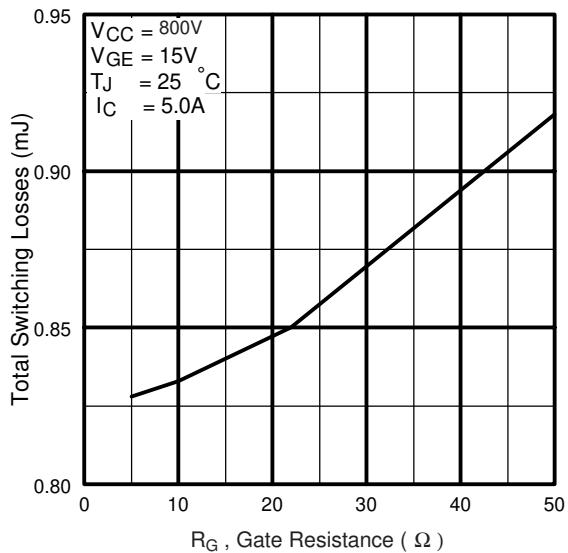
**Fig. 6** - Maximum Effective Transient Thermal Impedance, Junction-to-Case



**Fig. 7** - Typical Capacitance vs.  
Collector-to-Emitter Voltage

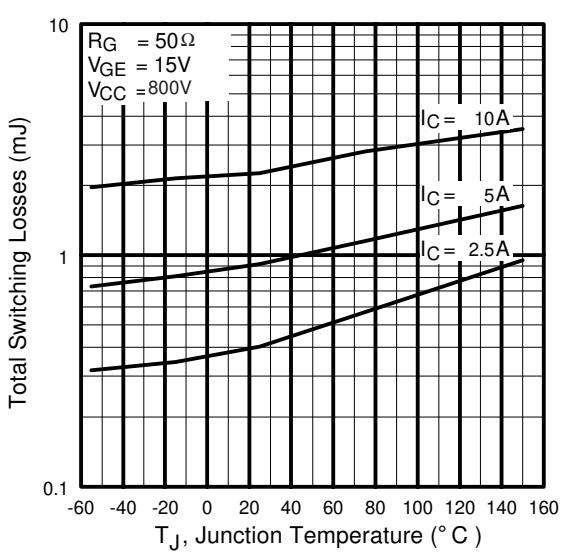


**Fig. 8** - Typical Gate Charge vs.  
Gate-to-Emitter Voltage



**Fig. 9** - Typical Switching Losses vs. Gate  
Resistance

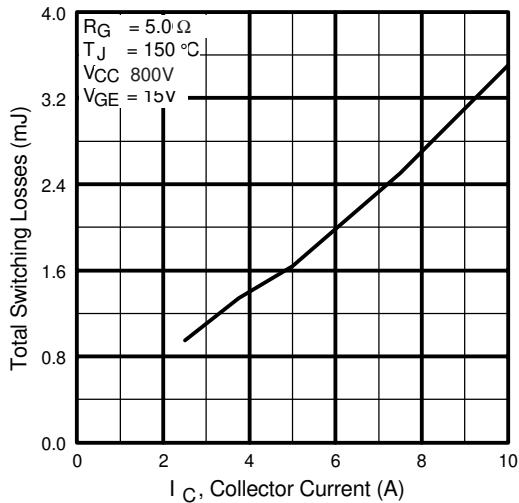
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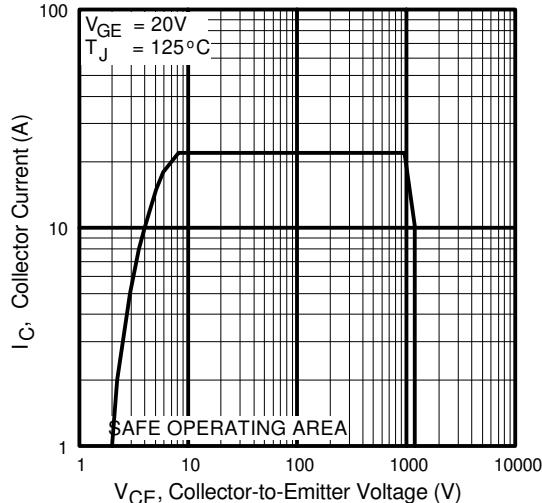
**Fig. 10** - Typical Switching Losses vs.  
Junction Temperature

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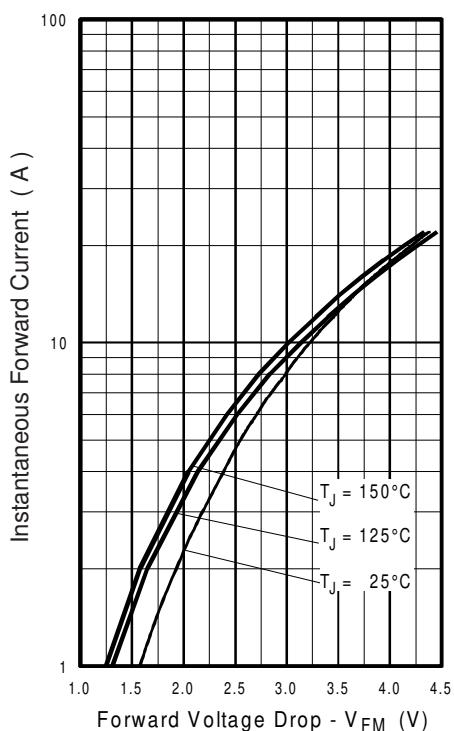
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**Fig. 11** - Typical Switching Losses vs.  
Collector Current

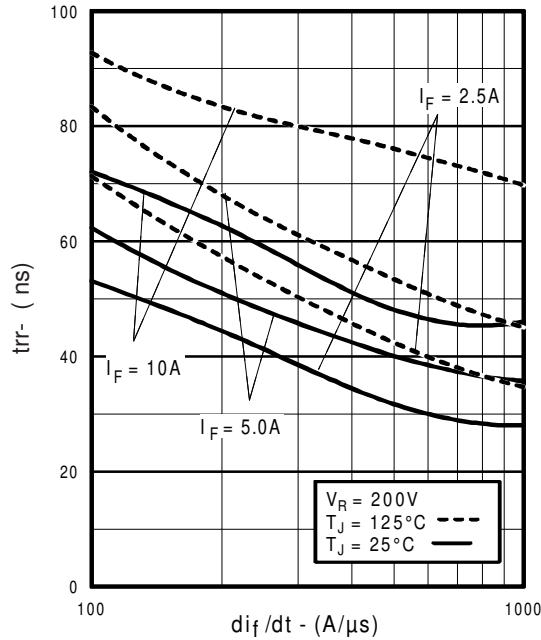


**Fig. 12** - Turn-Off SOA



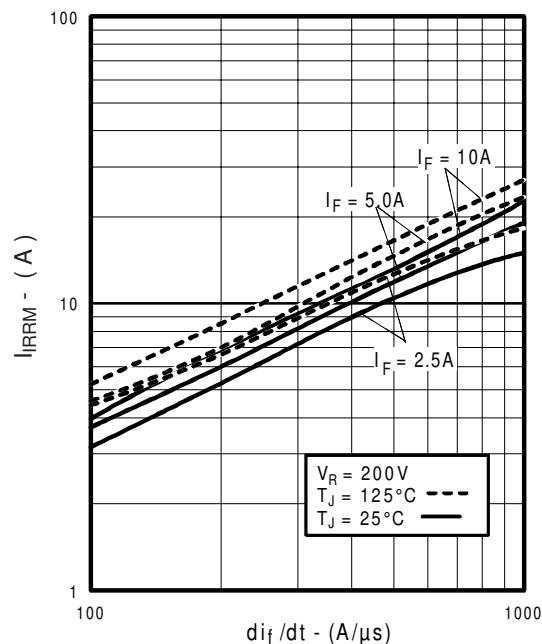
**Fig. 13** - Typical Forward Voltage Drop vs. Instantaneous Forward Current

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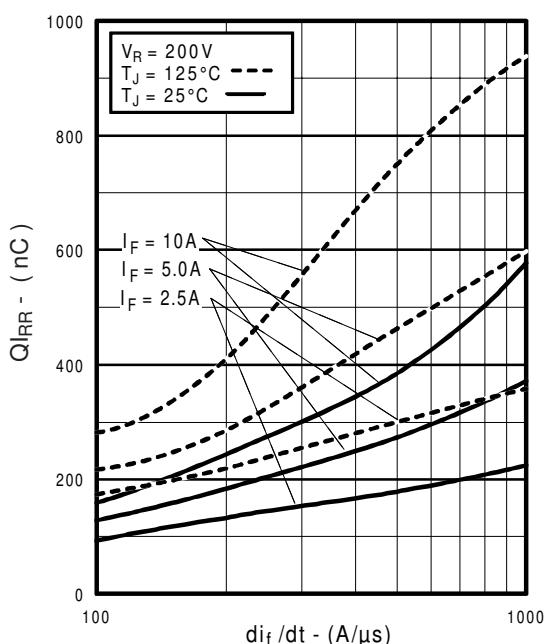


**Fig. 14** - Typical Reverse Recovery vs.  $di_f/dt$

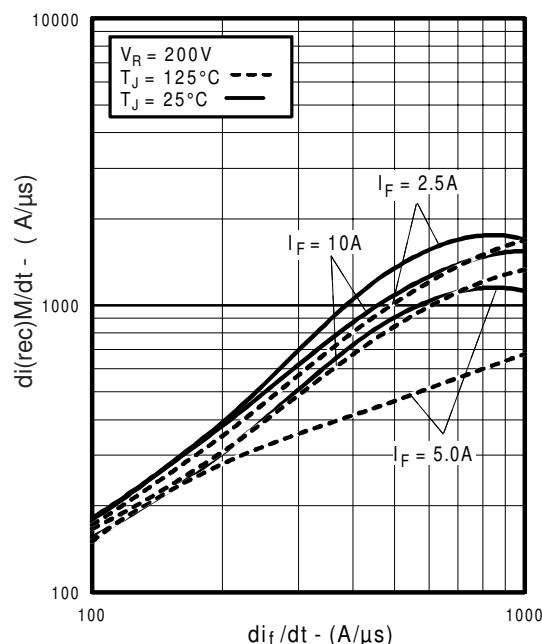
**IRG4PH20KD**



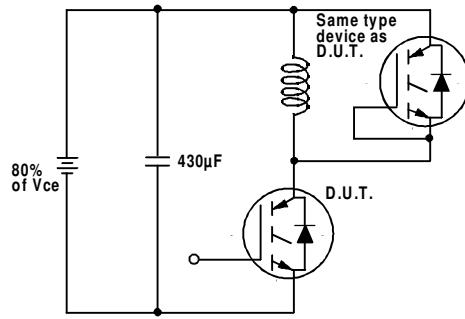
**Fig. 15** - Typical Recovery Current vs.  $di_f/dt$



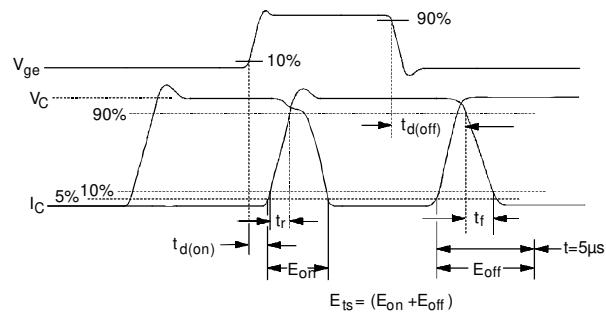
**Fig. 16** - Typical Stored Charge vs.  $di_f/dt$   
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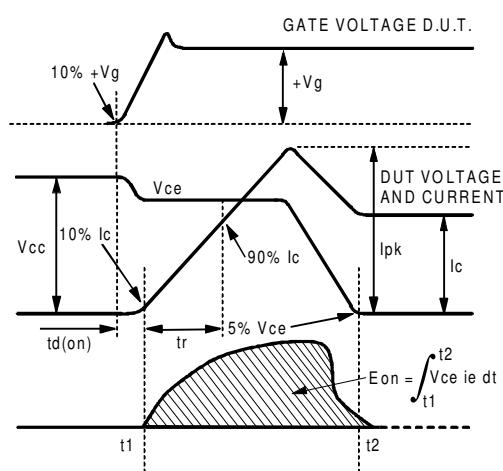
**Fig. 17** - Typical  $di_{(rec)}M/dt$  vs.  $di_f/dt$



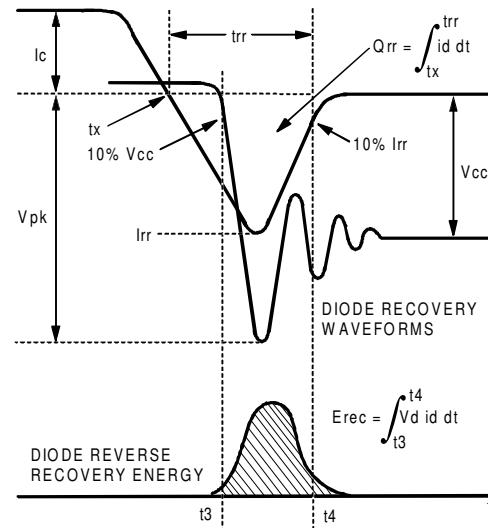
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off(diode)}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$

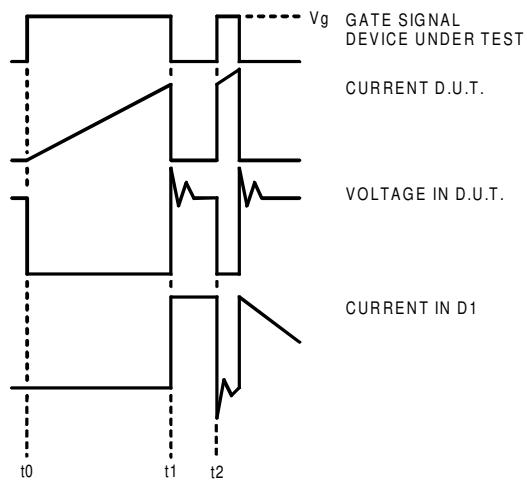


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

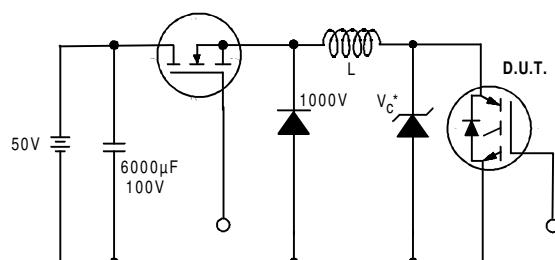


Figure 19. Clamped Inductive Load Test Circuit

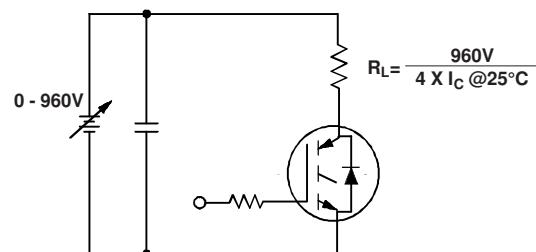


Figure 20. Pulsed Collector Current Test Circuit

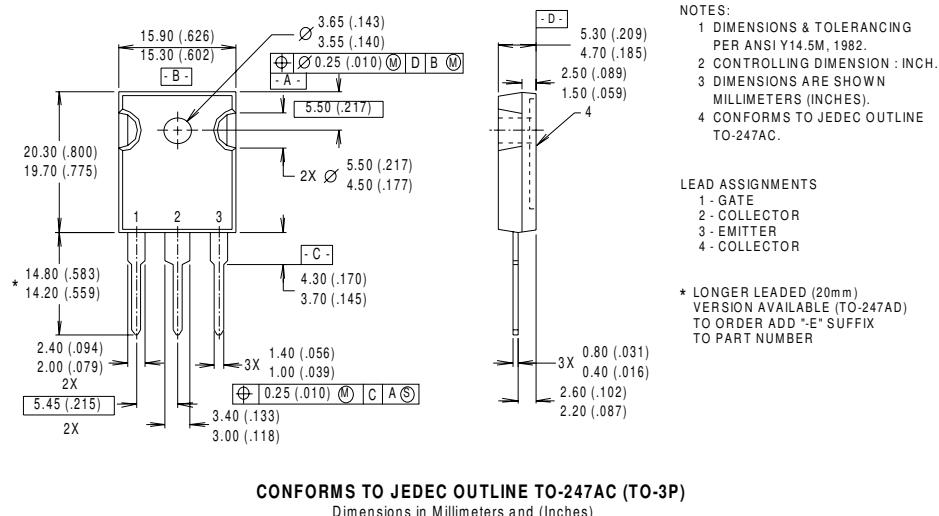
# IRG4PH20KD

International  
**IR** Rectifier

## Notes:

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC}=80\% (V_{CES})$ ,  $V_{GE}=20V$ ,  $L=10\mu H$ ,  $R_G=5.0\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu s$ , single shot.

## Case Outline - TO-247AC



NOTES:  
1 DIMENSIONS & TOLERANCING  
PER ANSI Y14.5M, 1982.  
2 CONTROLLING DIMENSION : INCH.  
3 DIMENSIONS ARE SHOWN  
MILLIMETERS (INCHES).  
4 CONFORMS TO JEDEC OUTLINE  
TO-247AC.

LEAD ASSIGNMENTS  
1 - GATE  
2 - COLLECTOR  
3 - Emitter  
4 - COLLECTOR

\* LONGER LEADED (20mm)  
VERSION AVAILABLE (TO-247AD)  
TO ORDER ADD "-E" SUFFIX  
TO PART NUMBER

International  
**IR** Rectifier

**WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, Tel: (310) 322 3331

**EUROPEAN HEADQUARTERS:** Hurst Green, Oxted, Surrey RH8 9BB, UK Tel: ++ 44 1883 732020

**IR CANADA:** 7321 Victoria Park Ave., Suite 201, Markham, Ontario L3R 2Z8, Tel: (905) 475 1897

**IR GERMANY:** Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 6172 96590

**IR ITALY:** Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111

**IR FAR EAST:** K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo Japan 171 Tel: 81 3 3983 0086

**IR SOUTHEAST ASIA:** 315 Outram Road, #10-02 Tan Boon Liat Building, Singapore 0316 Tel: 65 221 8371

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Note: For the most current drawings please refer to the IR website at:  
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